Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	19759	(capacitor capacitive) same (caposer interposing interposer interposed)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/11 09:33
L2	6656	((integrated adj circuit) ic die chip dice semiconductor component) same 1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/11 09:34
L3	1881	2 same (substrate board pcb ((wiring printed circuit) adj board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/11 09:35
L4	· 399	(flipchip (flip adj chip) bump ball) and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/11 10:06
L5	53	4 and (bypass (by adj pass))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/11 10:52
L6	13	5 and (asic (application with specific with ((integrated adj circuit) ic)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/11 10:54
L7	1	"5880925".PN.	USPAT; USOCR	OR	OFF	2005/09/11 10:58
L8	1	"6342681".PN.	USPAT; USOCR	OR	OFF	2005/09/11 10:58
L9	1	"6459561".PN.	USPAT; USOCR	OR	OFF	2005/09/11 10:59
L10	1	"6477032".PN.	USPAT; USOCR	OR	OFF	2005/09/11 10:59
L11	. 1	"20020101702".PN.	US-PGPUB	OR	OFF	2005/09/11 10:59
L12	1	"20030001287".PN.	US-PGPUB	OR	OFF	2005/09/11 10:59
L13	1	"20030062602".PN.	US-PGPUB	OR	OFF	2005/09/11 11:00

L14	1	"5633785".PN.	USPAT; USOCR	OR	OFF	2005/09/11 11:01
L15	1	"6137161".PN.	USPAT; USOCR	OR	OFF	2005/09/11 11:01
L16	1	"6144225".PN.	USPAT; USOCR	OR	OFF	2005/09/11 11:01
L17	1	"6477034".PN.	USPAT; USOCR	OR	OFF	2005/09/11 11:01
L18	1	"6683781".PN.	USPAT; USOCR	OR	OFF	2005/09/11 11:02